Leadership enterprise server with significantly lower cost of ownership in a highly available and expandable, rack-dense, 1U dual-socket server





February 2011



IBM System x3550 M3

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Outstanding innovation in only 1U

Suggested Uses: All sectors requiring highly available, energy-efficient, rack-optimized solution for physical and virtual intensive commercial environments like eBusiness/eCommerce, collaboration, virtualization, database, and enterprise resource planning applications.

Your challenge is to do more with less—serve more Web pages, handle more secure connections, support more e-mail users. You need to reduce the costs of doing business and improve the service you deliver to your customers while lowering your overall risk. The **dual-socket IBM® System x3550 M3** can reduce your costs with its new energy smart design. It can improve service with reduced operational complexity and increased management functionality. It will lower your IT risk with the resiliency that comes from no single point of failure. And like all IBM servers, the x3550 M3 offers you the trust that comes from the IBM global reach, service and support

The x3550 M3 is a game-changing rack server that uses significantly less power than previous generations, with unified systems management tools, leadership reliability, availability, and serviceability features and broad systems flexibility, housed in a compact 1U mechanical package.

The x3550 M3 features Intel[®] Xeon[®] 5600 series 6-core and 4-core processors, with up to 12MB of shared L3 cache, to provide you with the computing power you need to match your business needs and growth. The new line of Intel processors delivers unprecedented intelligent performance with features like adaptive performance for applications and environments, Turbo Boost Technology and Hyper-Threading Technology, and integrated power gates and automated power management.

The x3550 M3 supports up to 18 DIMMs / 192GB of registered (RDIMM) 1333MHz DDR3 memory (or up to 12 DIMMs / 48GB of unbuffered UDIMM memory) and provides Chipkill™ ECC (Error Checking and Correcting) protection—for high performance and reliability. For even higher levels of availability, the x3550 M3 also offers memory mirroring. Up to 4 integrated high-speed Gigabit Ethernet ports are available (offering TOE (TCP Offload Engine) support on Microsoft® Windows®), as are two high-performance adapter slots (PCle x16). The x3650 M3 offers an optional embedded hypervisor to manage your virtual workloads.

The x3550 M3 offers a choice of up to supports up to 8 high-performance hot-swap HDDs with an internal storage capacity of 8TB¹ (2.5-inch hot-swap Serial-Attached SCSI (SAS) or Serial-Attached ATA (SATA) drives). Alternatively, up to 8 solid-state drives (SSDs) are also available to keep power low, improve resiliency, and offer up to 400GB of storage. The server includes a choice of several IBM ServeRAID® storage controllers that provide broad levels of hardware-based RAID solutions. The ultradense 1U form factor allows businesses to increase their computing power and spread their workload without outgrowing their current data center. Up to 42 of these 1U servers can be installed in a single 42U rack, for a total of up to 84 processors and 504 processor cores, offering tremendous deployment flexibility.

Standard in the x3550 M3 is the Integrated Management Module (IMM) that enables the user to manage and control the server easily—both locally and remotely. In conjunction with the IMM, the x3550 M3 comes with an altitude sensor (altimeter) that governs fan rotation based on altitude, to help lower your energy consumption. The IMM offers a high level of manageability that is designed to keep costs down and the system up—even when network usage increases. IBM's innovative pop-out/drop-down light path diagnostics panel enables quick servicing of the system if a problem develops. These advanced features help maximize network availability by increasing uptime, as do hot simple-swap solid-state drives; hot-swap/redundant SAS or SATA HDDs, redundant ultra-efficient power supplies and fan modules; Active Memory™; integrated RAID; temperature-controlled fans with Calibrated Vectored Cooling™; IPMI 2.0 support, including highly secure remote power control and Serial over LAN; as well as text-console redirect over LAN.

¹ 1TB drives available in 2Q/2011.

Another improvement with the new generation of X-Architecture is the replacement of legacy BIOS with a new generation **United Extensible Firmware Interface** (UEFI). UEFI provides a more intuitive user interface and understandable event logs and better management.

With the inclusion of unique IBM service and support features such as the IMM, light path diagnostics, IBM Systems Director, IBM Systems Director Active Energy Manager, IBM ServerGuide and support for the optional Virtual Media Key for remote presence capability, the x3550 M3 is designed for superior uptime.

The x3550 M3 passed the NEBS 1/ETSI equivalent compliance for both AC and DC power supplies and compliance with 80 PLUS® and ENERGY STAR® standards (model dependent), demonstrating exceptional energy efficiency. For more information about IBM's ENERGY STAR compliance, visit http://ibm.com/systems/greendc/green_technology/energy_star/index.html.

If you need highly manageable, dual-socket/multi-core computing power in a rack-dense, energy-efficient package, the x3550 M3 is the ideal system.

Selling Features

Price/Performance

The x3550 M3 offers numerous features to boost performance and reduce costs:

- Up to two 6-core or 4-core Xeon 5600 series processors and up to 12MB of cache per
 processor, offer superior performance capable of tackling the toughest jobs. Xeon 5600 series
 processors offer up to 54% better performance than the previous-generation 5500 series
 processors (depending on workload).
- Low-voltage processors draw less energy and produce less waste heat than high-voltage processors, thus helping to reduce data center energy costs. Selected 4-core Xeon 5600 series processors (available via CTO) use only 40W, and selected 6-core processors consume only 60W. This is less than half the wattage consumed by 130W processors.
- Eighteen DIMMs of ultra-fast registered 1333MHz DDR3 ECC memory with Chipkill² protection (optional) provide speed, high availability, and a memory capacity of up 192GB.
- x3550 M3 servers using the L5640, E5645, E5649 and 1333MHz X56xx processors support 2 DIMMs per channel (2DPC) at 1333MHz (running at 1.5V).
- Optional 50GB solid-state drives (SSD) use only 2W of power per drive, vs. 9-10W for 2.5-inch HDDs. This is as much as 80% less power than a 2.5-inch HDD would use (with a corresponding reduction in heat output).
- The altimeter works in conjunction with IMM to govern fan rotation. which can help save money at lower altitudes because the fans do not have to spin at high speed.
- Two high-speed PCle x16 adapters (Gen 2) slots offer investment protection by supporting high-performance adapters, such as 10Gb Ethernet, Fibre Channel and InfiniBand™ cards, none of which will run in older 33MHz and 66MHz conventional PCl slots.
- The integrated ServeRAID-BR10il v2 controller (model-specific) provides RAID-0/1/1E and full-duplex (bidirectional 3Gbps) data transfers for SAS/SATA/SSD drives without consuming a valuable adapter slot. Other server models include the 6Gbps ServeRAID-M1015 (RAID-0/1/10, optional 5/50 with Self-Encrypting Disk, or SED), the 6Gbps ServeRAID-M5014 controller, which provides RAID-0/1/10/5/50 with 256MB cache and optionally 6/60 with SED and optional battery backup, or the 6Gbps ServeRAID-M5015 controller, which provides RAID-0/1/10/5/50 with 512MB of battery-backed cache (except CTO models) and optionally 6/60 with SED.
- Up to 8 2.5-inch hot-swap SAS/SATA hard disk drives offer high-performance with high availability. SSDs offer even higher availability, with extremely high IOPS rates.
- The integrated dual-port Gigabit Ethernet controller with IPMI 2.0 provide high-speed network communications. Two more NICs can be added to the planar with an additional dualport Gb Ethernet daughtercard. The TCP Offload Engine (TOE) feature offers higher performance for TCP/IP traffic, with less overhead on the system processor.
- A high degree of device integration—including SAS/SATA HDDs or SSDs, multiple ServeRAID options, Gigabit Ethernet ports, systems management and video controllers—lowers costs and frees up valuable adapter slots.
- Energy-efficient components, including DDR3 memory, low-voltage transistors and voltage regulator modules, and power supplies that are up to 90% efficient (model-specific), help keep your energy bills down.

Xeon inside*

² All models require Chipkill-enabled DIMMs (provided standard) for Chipkill protection.

Flexibility

The x3550 M3 has the ability to grow with your application requirements, thanks to

- A choice of 4-core or 6-core processors with 1.6 to 3.6GHz clock rates, up to 6.4 gigatransfers per second, and 40W to 130W maximum power draw.
- Up to 192GB of high-speed registered DDR3 system memory.
- A choice of either 1.5V DIMMs, or 1.35V DIMMs that consume 20% less energy.
- A choice of power supplies, including 460W, 675W AC or DC, or energy-efficient 675W.
- Two available high-performance PCle x16 adapter slots in all models. Optionally, one riser card supporting PCl-X/133 adapters can be exchanged for one PCle slot.
- Upgrading to the ServeRAID-M5015 controller provides 512MB of battery-backed cache to enable higher-performance hardware RAID support, and allows the x3550 M3 to offer five RAID levels standard: RAID-0/1/10/5/50 (and optionally 6/60 with SED).
- The five USB 2.0 ports (two front, two rear, one internal) are up to 40X faster³ than older USB 1.1 ports. This provides speedy access to external HDDs (non-arrayed), optical drives, tape drives, and other USB devices. Two ports are on the front of the unit and two are on the back. The internal port supports a flash drive with embedded hypervisor.
- A choice of up to eight 2.5-inch hot-swap SAS/SATA HDDs or solid-state drives, or four
 2.5-inch drives and one internal optical drive, offer a variety of storage options. The SAS and
 SATA HDD models provide a maximum of 8TB of internal hot-swap storage. The x3550 M3
 supports a mix of hot-swap SAS, SATA and SSD drives.
- Alternatively, direct-attach, network-attached storage (NAS), or iSCSI or Fibre Channelattached storage can be attached using IBM System Storage™ servers.

Manageability / Security

Powerful systems management features simplify local and remote management of the x3550 M3:

- The x3550 M3 includes an Integrated Management Module (IMM) to monitor server availability, perform Predictive Failure Analysis, etc., and trigger IBM Systems Director alerts. The IMM performs the functions of both the Baseboard Management Controller (BMC) of earlier systems and the Remote Supervisor Adapter II and is upgradeable to remote presence/cKVM.
- An optional Virtual Media Key provides additional systems management capabilities, including Web-based out-of-band control; virtual floppy and optical drive support; Windows "blue screen" error capture; LDAP and SSL support; and remote redirection of PCI video, text, keyboard and mouse (cKVM). And it does all this without consuming a valuable adapter slot.
- Integrated industry-standard Unified Extensible Firmware Interface (UEFI) next-generation BIOS. New capabilities include:
 - Human readable event logs no more beep codes
 - Complete setup solution by allowing adapter configuration function to be moved into UEFI
 - Complete out-of-band coverage by Advance Settings Utility to simplify remote setup
- Integrated Trusted Platform Module (TPM) 1.2 support.
- Integrated IPMI 2.0 support alerts IBM Systems Director to anomalous environmental factors, such as voltage and thermal conditions. It also supports highly secure remote power control using data encryption.
- Text Console Redirection support allows the administrator to remotely view x3550 M3 text messages over Serial or LAN.
- IBM Systems Director 6.1x is included for proactive systems management. IBM Systems
 Director comes with a portfolio of tools, including IBM Systems Director Active Energy
 Manager™, Service and Support Manager, and others. In addition, IBM Systems Director
 offers extended systems management tools for additional server management and increased
 availability. When a problem is encountered, IBM Systems Director can issue administrator
 alerts via e-mail, pager, and other methods.
- IBM Systems Director Active Energy ManagerTM, an IBM-exclusive, is designed to take
 advantage of new system power management features, by providing actual realtime energy
 monitoring, reporting, and capping features.

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³ Data transfer rates may be less than the maximum possible.

Availability and Serviceability

The x3550 M3 provides many features to simplify serviceability and increase system uptime:

- x3550 M3 servers offer Chipkill ECC memory protection⁴ (when using x4 DIMMs). Chipkill
 memory is up to 16X better than standard ECC memory at correcting memory errors. This can
 help reduce downtime caused by memory errors.
- The x3550 M3 offers selectable memory mirroring for redundancy in the event of a noncorrectable memory failure
- Toolless cover removal provides easy access to upgrades and serviceable parts such as
 HDDs and memory. Similarly, the Virtual Media Key and the ServeRAID controller can be
 installed and replaced without tools. This means less time (and therefore less money) spent
 servicing the x3550 M3. Similarly, hot-swap/redundant HDDs, fan modules and power
 supplies, as well as online mirrored memory, mean greater system uptime while these
 components are being serviced.
- New toolless slides ship with the server, together with a Cable Management Arm (CMA), that allows the rack server to easily slide into place
- IBM Thermal Diagnostics allows the administrator to evaluate thermal data on the server without taking the hardware offline. This can provide greater server uptime.
- The drop-down light path diagnostics panel and individual light path LEDs quickly lead the technician to failed (or failing) components. This simplifies servicing, speeds up problem resolution and helps improve network availability.
- Integrated 3Gbps or 6 Gbps RAID controller to enhances system availability and data protection without using a valuable PCIe slot.
- IPMI 2.0 supports highly secure remote system power control using data encryption. This
 allows an administrator to restart a server without having to visit it in person, saving travel time
 and getting the server back up and running quickly and securely. It also adds new features to
 those provided by IPMI 1.5, including VLAN support, Serial over LAN, enhanced
 authentication and encryption algorithms (RMCP+ and AES) and a firmware firewall.
- Altitude- and temperature-controlled fans adjust to compensate for changing thermal
 characteristics. At the lower speeds they draw less power and suffer less wear. Equally
 important in a crowded data center, temperature-controlled fans produce less ambient noise in
 the data center than if they were constantly running at full speed.
- The three-year (parts and labor) limited onsite warranty⁵ helps afford you peace of mind and greater investment protection than a one-year warranty does.

Key Features

High-Performance / High-Efficiency Xeon 5600 Series Processors

The x3550 M3 supports up to two high-performance Intel **Xeon 5600** series processors, allowing you to upgrade to a second processor as your business needs require. The x3550 M3 offers a choice of processor clock rates, memory access speeds and energy draw, including:

- 130W 6-core Xeon 5600 model X5690 running at 3.46GHz, with impressive performance/watt (21.67W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 95W 6-core Xeon 5600 models X5675 or X5650 running at 3.06 or 2.66GHz, respectively, with reduced draw and impressive performance/watt (only 15.83W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 80W 6-core Xeon 5600 models E5649 or E5645 running at 2.53 or 2.4GHz, respectively, with reduced power draw and impressive performance/watt (only 13.33W per core; 5.86GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 60W 6-core Xeon 5600 low-voltage model L5640 running at 2.26GHz, respectively, with low power draw and impressive performance/watt (only 10W per core; 5.86GTps QPI speed), and 12MB of shared L3 cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 80W 4-core Xeon 5600 models E5620 running at 2.4GHz, respectively, with reduced power



⁵ For terms and conditions or copies of the IBM Statement of Limited Warranty, call 800-772-2227 in the U.S. In Canada call 800-426-2255. Telephone support may be subject to additional charges. For warranties including onsite labor, a technician is sent after IBM attempts to resolve the problem remotely. International warranty service is available in any country in which this product is sold.





draw and impressive performance/watt (20W per core; 5.86GTps QPI speed), 12MB of L3 processor cache, 1066MHz memory access, 2 threads per core, and Intel Turbo Boost technology

- 80W 4-core Xeon 5600 models E5607 or E5606 running at 2.26 or 2.13GHz, respectively, with reduced power draw and impressive performance/watt (20W per core; 4.8GTps QPI speed), 8MB of L3 processor cache, and 1066MHz memory access
- 80W 4-core Xeon 5600 models E5603 running at 1.6GHz with reduced power draw and impressive performance/watt (20W per core; 4.8GTps QPI speed), 4MB of L3 processor cache, and 1066MHz memory access

Also available, via configure-to-order (CTO):

- 130W 4-core Xeon 5600 model X5687 running at 3.6GHz, with impressive performance (32.5W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 95W 4-core Xeon 5600 model X5672 running at 3.2GHz, with reduced draw and impressive performance/watt (23.75W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 95W 6-core Xeon 5600 model X5660 running at 2.8GHz, with reduced draw and impressive performance/watt (only 15.83W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 130W 4-core Xeon 5600 model X5647 running at 2.93GHz with impressive performance (32.5W per core; 5.86GTps QPI speed), 12MB of L3 processor cache, 1066Hz memory access, 2 threads per core, and Intel Turbo Boost technology
- 40W 4-core Xeon 5600 low-voltage model L5630 running at 2.13GHz, with extremely low
 power draw and amazing performance/watt (only 10W per core; 5.86GTps QPI speed), 12MB
 of L3 processor cache, 1066MHz memory access, 2 threads per core, and Intel Turbo Boost
 technology
- 40W 4-core Xeon 5600 low-voltage model L5609 running at 1.86GHz, with extremely low power draw and amazing performance/watt (only 10W per core; 4.8GTps QPI speed), 12MB of L3 processor cache, and 1066MHz memory access

With the Xeon 5600 series processors, Intel has diverged from its traditional Symmetric Multiprocessing (SMP) architecture to a Non-Uniform Memory Access (NUMA) architecture. The processors are connected through serial coherency links called QuickPath Interconnect (QPI). QPI is capable of 6.4, 5.86 or 4.8 GTps (gigatransfers per second), depending on the processor model.

4-core Xeon processors contain *four complete processor cores*; **6-core** processors, similarly, contain **six** cores. Each 5600 series processor contains one **256KB L2** cache **per** core and one **12MB L3** cache shared by all the cores. The shared cache is dynamically allocated between the cores as needed. The multiple cores appear to software as multiple physical processors. The 2-core processors offer considerably higher performance than a same-speed Xeon processor with a single core. Likewise, 4-core processors offer considerably higher performance than a same-speed Xeon processor with 2 cores.

Turbo Boost Technology increases performance by translating the temperature, power and current head room into higher frequency. It will dynamically increase by 133MHz for short and regular intervals until the upper limit is met or the maximum possible upside for the number of active cores is reached. The maximum frequency is dependent on the number of active cores. The amount of time the processor spends in the Turbo Boost Technology state depends on the workload and operating environment, providing the performance you need, when and where you need it. For example, a **3.46GHz 6-core X5690** processor with **3-6** cores active can run the cores at **3.6GHz**. With only **one** or **two** cores active, the same processor can run those cores at **3.73GHz**. Similarly, a **3.6GHz 4-core X5687** processor can run at **3.73GHz** or even **3.86GHz**. When the inactive cores are needed again, they are dynamically turned back on and the processor frequency is adjusted accordingly.

In processors implementing **Intel Hyper-Threading Technology**, each core has two threads capable of running an independent process. Thus, a 6-core processor can run **12** threads concurrently.

Intelligent Power Capability powers individual processor elements on and off as needed, to reduce power draw.

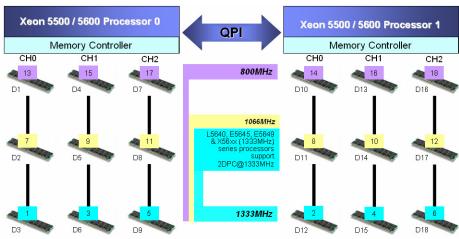
Execute Disable Bit functionality can help prevent certain classes of malicious buffer overflow attacks when combined with a supporting operating system.

Intel's **Virtualization Technology** (VT) integrates hardware-level virtualization hooks that allow operating system vendors to better utilize the hardware for virtualization workloads.

DDR3 Memory with Chipkill ECC Protection

The x3550 M3 ships with registered double data rate III (DDR3) memory and provides Active Memory features, including advanced **Chipkill** memory protection (using x4 DIMMs), for **up to 16X** better error correction than standard ECC memory. In addition to offering better performance than DDR2 or fully-buffered memory, DDR3 memory also uses less energy. DDR2 memory already offered up to 37% lower energy use than fully buffered memory. Now, a generation later, DDR3 memory is even more efficient, using up to **15% less energy** than DDR2 memory.

The x3550 M3 currently supports up to **144GB** of **RDIMM** (registered DIMM) memory in **18** DIMM slots (**192GB** in **12** slots), or up to **48GB** of **UDIMM** (unbuffered DIMM) memory in **12** slots. The x3550 M3 also supports either energy-efficient **1.35V** DIMMs or standard **1.5V** DIMMs. Redesign in the architecture of the Xeon 5500 and 5600 series processors bring radical changes in the way memory works in these servers. For example, the Xeon 5500 and 5600 series processors integrate the memory controller inside the processor, resulting in two memory controllers in a 2-socket system. Each memory controller has three memory channels. Depending on the type of memory, population of memory, and processor model, the memory may be clocked at **1333MHz**, **1066MHz** or **800MHz**.



1-18: DIMM population sequence, D1-D18: DIMM slot assignments

Note: If only one processor is installed, only the first nine DIMM slots can be used. Adding a second processor not only doubles the amount of memory available for use, but also doubles the number of memory controllers, thus doubling the system memory bandwidth. If you add a second processor, but no additional memory for the second processor, the second processor would have to access the memory from the first processor "remotely," resulting in longer latencies and lower performance. The latency to access remote memory is almost 75% higher than local memory access. So, the goal should be to always populate both processors with memory.

The 1333MHz **E**56xx, **L**5640, and **X**56xx processor models support up to **1333MHz** memory clock speed and 2 DIMMs per channel (2DPC) at 1333MHz with single-rank and dual-rank RDIMMs and UDIMMs running at 1.5V. Other processors access memory at **1066MHz**.

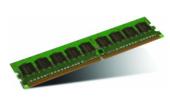
Using 1333MHz memory (where supported) versus 1066MHz DIMMs offers up to **9**% better performance, while 1066MHz memory produces up to **28**% better performance than 800MHz memory. Xeon 5550/5600 series processors access memory with almost **50**% **lower latency** than the earlier 5400 series processors. That can result in faster processing of latency-sensitive workloads.

Regardless of memory *speed*, the Xeon 5600 platform represents a significant improvement in memory *bandwidth* over the previous Xeon 5400 platform. At 1333MHz, the improvement is almost **500**% over the previous generation. This huge improvement is mainly due to the dual integrated memory controllers and faster DDR3 1333MHz memory. Throughput at 800MHz is **25 gigabytes per second** (GBps); at 1066MHz it's **32GBps**; and at 1333MHz it's **35GBps**. This improvement translates into improved application performance and scalability.

Memory interleaving refers to how physical memory is interleaved across the physical DIMMs. A balanced system provides the best interleaving. A Xeon 5500/5600 processor-based system is balanced when all memory channels on a socket have the same amount of memory.

The Xeon 5600 series processors support single-, dual-, and quad-rank memory. A memory rank is simply a segment of memory that is addressed by a specific address bit.

A typical memory DIMM description is 8GB 2Rx4 DIMM:





- The 2R designator is the rank count for this particular DIMM (2R = dual-rank)
- The x4 designator is the data width (in bits) of the rank

It is important to ensure that DIMMs with the appropriate number of ranks are populated in each channel for optimal performance. Whenever possible, **use dual-rank DIMMs** in the system. Dual-rank DIMMs offer better interleaving and hence better performance than single-rank DIMMs. For instance, a system populated with six 2GB *dual*-rank DIMMs outperforms a system populated with six 2GB *single*-rank DIMMs by 7% for SPECjbb2005. Dual-rank DIMMs are also better than quad-rank DIMMs because **quad-rank DIMMs will cause the memory speed to be down-clocked**.

Another important guideline is to populate equivalent ranks per channel. For instance, **mixing one** single-rank DIMM and one dual-rank DIMM in a channel should be avoided.

Notes: It is important to populate all three memory channels in each processor. The relative memory bandwidth decreases as the number of channels populated decreases. This is because the bandwidth of all the memory channels is utilized to support the capability of the processor. So, as the channels are decreased, the burden to support the requisite bandwidth is increased on the remaining channels, causing them to become a bottleneck. RDIMMs and UDIMMs **cannot** be used in the same server. If 1.5V and 1.35V DIMMs are mixed, *all* DIMMs will run at 1.5V.

In addition to Chipkill error correction, the x3550 M3 offers an additional level of IBM Active Memory protection: **memory mirroring.**

Memory mirroring works much like disk mirroring. The total memory is divided into three channels: a primary channel, a backup channel, and an unused channel. Data is written concurrently to both the primary and backup channels. If a DIMM fails in one of the DIMMs in the primary channel, it is instantly disabled and the mirrored memory in the backup channel becomes active (primary) until the failing DIMM is replaced. One-third of total memory is available for use at any one time with mirroring enabled. (Note: Due to the double writes to memory, performance is affected.) Because the third channel is disabled with mirroring active, there is no point in populating it with memory.

Mirroring is handled at the hardware level; no operating system support is required.

DDR3 memory is currently available in **2GB**, **4GB**, **8GB** and **16GB** RDIMMs, as well as **2GB** and **4GB** UDIMMs. DIMMs are installed individually (not in pairs). However, for performance reasons, in a 2-processor system, it's best to install a DIMM per processor.

Maximum memory capacity and speed in 2-processor configurations include:

Memory Frequency	DIMMs per Channel	Max. Memory Capacity	5600 Series
1333MHz	1 (6 DIMMs)	48GB RDIMM 24GB UDIMM	1333MHz E56xx, L5640, and X56xx
1333MHz	2 (12 DIMMs)	96GB RDIMM 48GB UDIMM	1333MHz E56xx, L5640, and X56xx
1066MHz	2 (12 DIMMs)	96GB RDIMM 48GB UDIMM	E560x, E5620, L5609, L5630, and X5647
800MHz	3 (18 DIMMs)	144GB RDIMM	All
800MHz	2 (12 DIMMs)	192GB RDIMM	All
800MHz- 1333MHz	2 (8 DIMMs)	64GB RDIMM 16GB UDIMM	All

Integrated Virtualization



All models of the x3550 M3 support a **USB 2.0 Flash Key** installed preloaded with **VMware vSphere Hypervisor** (formerly ESXi). Rather than management through a Service Console based on a Linux operating system, vSphere Hypervisor relies on aggregate management tools, including VirtualCenter, the Remote Command Line interface and the introduction of CIM for standards-based and agentless hardware monitoring.

vSphere Hypervisor includes all the performance, scalability and compatibility features of a hypervisor installed on disk, including full **VMFS** support across FC SAN, iSCSI SAN, and NAS, and **4-way VSMP**. Because it runs from flash memory, it's extremely fast and ideal for diskless configurations. It also offers enhanced security, because it runs without an operating system-based console and is updated/patched much like firmware.

Disk Controllers

All x3550 M3 models include a **ServeRAID-BR10il v2**, **ServerRAID-M1015**, **ServeRAID-M5014** or **ServeRAID-M5015** SAS/SATA controller standard (model-dependent) to enhance system availability and data protection without using a PCI slot.

The 3Gbps^6 (x4 PCIe) **ServeRAID-BR10il v2** controller offers hardware **RAID-0/1/1E** support (no cache) for up to 4 HDDs or SSDs.

The 6Gbps (x8 PCIe) ServeRAID-M1015 SAS/SATA controller supports RAID-0/1/10 (no cache) for up to 32 drives (limited to available drive bays). The IBM ServeRAID M1000 Series Advance Feature Key adds RAID-5/50 with SED support.

The 6Gbps (x8 PCIe) ServeRAID-M5014 SAS/SATA controller offers enhanced performance with 256MB of cache memory, and supports RAID-0/1/10/5/50 for up to 32 drives (limited to available drive bays.

The **6Gbps** (x8 PCIe) **ServeRAID-M5015 SAS/SATA** controller offers enhanced performance with **512MB** of cache memory and battery backup⁷, and supports **RAID-0/1/10/5/50** for up to 32 drives (limited to available drive bays).

For external storage, the **6Gbps ServeRAID-M5025** controller enables connection to external IBM System Storage expansion units (up to 240 HDDs), as well as support for up to 8 internal HDDs (system limit). It provides RAID-0/1/10/5/50 support, **512MB** of onboard cache, and battery backup standard.

The IBM ServeRAID M5000 Series Advance Feature Key adds RAID-6/60 with SED support to the M5014, M5015, or M5025. The IBM ServeRAID M5000 Series Battery Key adds battery backup support to the M5014 and CTO systems containing an M5015 or M5025.

Drive Bays

The x3550 M3 supports up to **8** drive bays. Base models include **4 2.5-inch** drive bays. Optionally, add **one 5.25-inch** bay for an optional DVD-RW drive, or (using an expansion kit) increase the number of 2.5-inch bays to 8, However, these upgrades are mutually exclusive. Upgrading from 4 2.5-inch drive bays to 8 2.5-inch drive bays would require removal of the 5.25-inch bay, if present. The 2.5-inch bays support a combination of SATA and SAS HDDs, as well as solid-state drives (SSDs)

Hot-swap drives may be inserted or removed through the front of the server without powering off the system. **Simple-swap** solid-state drives can be inserted or removed through the front of the server as well; however, the system power must first be turned off.

For additional storage, a direct-attach, NAS or SAN external expansion option can be added, using an optional controller.

No diskette drive is supplied with any model; an external USB floppy drive may be used, if needed.

Flexible Internal Storage

The x3550 M3 offers flexibility with 4 2.5" HDD bays standard and optionally 8 2.5" HDD bays, supporting high-performance drives that provide high density/high reliability and allow you to scale up as your business grows.

2.5-inch Hot-Swap SAS

- 7,200 RPMs 500GB or 1TB8 (4TB maximum capacity with 4 bays / 8TB with 8 bays)
- 10,000 RPMs 73.4, 146.8, 300 or 600GB (2.4TB / 4.8TB)
- 15,000 RPMs 73.4 or 146.8GB (576GB / 1.17TB)

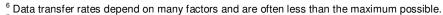
2.5-inch Hot-Swap SATA

- 7,200 RPMs 160, 250, or 500GB, or 1TB (4TB / 8TB maximum)
- 10,000 RPMs 300GB (1.2TB / 2.4TB)

2-5-inch HDDs not only require less space than 3.5-inch drives, they weigh less, consume half the power, produce less noise, seek faster, and offer increased reliability.

2.5-inch Hot-Swap or Simple-Swap SSDs

- 50GB High IOPS (200GB / 400GB maximum)
 - ☐ High I/O Performance



Battery backup is included when the adapter is purchased as an option or when included in standard server models. It is optional when the adapter is included in a CTO system.







- Offers up to 8X more IOPS than HDDs (67/33% read/write OLTP transaction base mix)
- Optimized for heavy mix of read and write operations, such as transaction processing, media streaming, surveillance, file copy, logging, backup/recovery, and business Intelligence

□ Lower-Cost IOPS Performance

- Yields better \$/IOPS: lower capacity (GB) required to achieve higher IOPS
- Uses less energy and generates less heat than a hard disk drive

□ Superior Uptime

- 3X the availability of mechanical disk drives
- No moving parts to fail
- Enterprise wear-leveling to extend life even further

☐ Full OS Support

Supports all ServerProven OSes

The hot-swap SAS drives use the Converged Tray for interchangeability with other IBM System x^{\otimes} systems. If you need more storage space, terabyte capacities are possible with external IBM System Storage direct-attach, NAS and SAN offerings.

High-Performance Adapter Slots

The x3550 M3 provides **two x16** ("by 16") **16GBps PCIe Gen 2 (PCI Express) Gen 2** I/O slots for long-term investment protection. **PCI Express** Gen 2 is the next-generation of high-performance, low-latency, serial I/O bus. Each slot is capable of supporting **x1/x4/x8/x16** Gen 1 or Gen 2 adapters at full speed. One slot is **full**-height, **half**-length. The other is **low profile**. Each is convertible to one PCI-X/133 MHz using an optional riser. High-performance x16 Gen 2 slots are ideal for digital media, 2D graphics environments, and other I/O-intensive applications.

There is also a dedicated riser card in the x3550 M3 that provides a x8 PCIe connector wired with x4 lanes for an internal ServeRAID card.

Dual-Port Gigabit Ethernet Controller

The x3550 M3 includes **one dual-port** integrated **Broadcom 5709S** Gigabit Ethernet controller standard, for up to 10X higher maximum throughput than a 10/100 Ethernet controller, as well as support for **TOE** (TCP Offload Engine), as well as **load-balancing** and **failover** capabilities between the two ports.

TOE helps improve overall system performance by offloading TCP/IP protocol processing from the system microprocessor to the onboard Ethernet TOE processor.

It also supports highly secure remote power management using **IPMI 2.0**, plus **Wake on LAN**[®] and **PXE** (Preboot Execution Environment) flash interface. Optional PCI adapters offering failover and load balancing between adapters are available for added throughput and increased system availability.

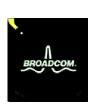
Integrated guad Gb Ethernet ports:

- Up to four Gb Ethernet ports, ideal for virtualization and I/O-intensive workloads
- · 2 ports standard, plus two additional ports via optional daughtercard
- Improves system performance by offloading protocol processing from CPU to a separate TOE engine
- Primary performance improvement for data copying (CPU) where CPU utilization is 90-100%

The 5709S controller supports IEEE 802.3 for 1000Base-T, 100Base-TX, and 10Base-T applications (802.3, 802.3u, 802.3ab) through a RJ-45 connector to an Ethernet network over a CAT 5 twisted-pair cable. TOE support on Windows is available today, but requires the Windows Scalable Network Pack (SNP) installed. Linux has no plan to support TOE at this time.

10 Gigabit Ethernet Integrated Virtual Fabric Adapter for IBM

The Emulex Virtual Fabric Adapter for x3550 M3 (part number 49Y4200 with special riser card, support by CTO) is an industry-leading performance and scalability per watt, dual-port network adapter for 10Gbps Ethernet (10GbE) networks. It offers the benefits and flexibility of I/O convergence in a single end-to-end solution. Protocol offload for stateless TCP/IP and TCP Chimney provide maximum bandwidth with minimum use of CPU resources. It achieves line rate 10Gbps performance with support for TCP/IP stateless offloads and TCP Offload Engine (TOE) support. TOE reduces system processor utilization, providing increased system performance and



^{8 1}TB SAS and 250GB/1TB SATA drives available in 2Q/2011.

reducing overall system power requirements.

The Emulex 10Gb/s Virtual Fabric Adapter for IBM System x3550 M3 is based on the Emulex OneConnect Universal Converged Network Adapter (UCNA) platform that also includes the capability for future upgrades to Fibre Channel over Ethernet (FCoE) and iSCSI protocol offloads. By using a common infrastructure for Ethernet and storage networks, data centers can reduce capital expense (CapEx) for adapters, switches and cables, and operational expense (OpEx) for power, cooling and IT administration.

End-to-end data protection with hardware parity, CRC, ECC and other advanced error checking and correcting ensure that data is safe from corruption.

Integrated dual 10Gbps Ethernet ports:

- IPv4/IPv6 TCP, UDP checksum offload; Large Send Offload (LSO); Large Receive Offload; Receive Side Scaling (RSS); IPV4 TCP Chimney Offload
- · VLAN insertion and extraction
- · Jumbo frames up to 9000 Bytes
- Preboot eXecutive Environment (PXE) 2.0 network boot support
- Interrupt coalescing
- Load balancing and failover support including adapter fault tolerance (AFT), switch fault tolerance (SFT), adaptive load balancing (ALB), teaming support and IEEE 802.3ad.

Ultra-Efficient Cooling



Strategically located fans, combined with efficient airflow paths, provide highly effective system cooling for the x3550 M3, known as **Calibrated Vectored Cooling**. The base server with one power supply includes **one** hot-swap fan module, upgradeable to **six** modules, for redundant cooling. Each module includes two back-to-back fans with counterrotating blades. In addition, each power supply also contains a fan.

The system contains **three cooling zones**. **Zone 1** (incorporating two fan modules) cools all 18 DIMM sockets, **Zone 2** (two fan modules) cools the primary processor, and **Zone 3** (one or two fan modules) cools the second processor (if installed).

The fans automatically adjust speeds in response to changing thermal requirements depending on the zone and internal temperatures. When the temperature inside the server increases, the fans speed up to maintain the proper ambient temperature. When the temperature returns to a normal operating level, the fans return to their default speed. In addition, the **Bosch BMP085 altimeter** works in conjunction with IMM to govern fan rotation. At high altitudes the air is thinner and doesn't cool as well as at lower elevations. In most servers, the fans run fast all the time to allow for use at high elevations, wasting power. The altimeter allows the IBM fans to run at lower speeds at lower altitudes.

Why not simply run the fans at 100% capacity all the time? For several good reasons: to reduce the ambient noise, reduce the wear-and-tear on the fans and reduce the server power draw. The reduction in ambient noise and power draw may be relatively minor for a single server, but put dozens or hundreds in a data center and it can make a big difference!

In addition, the server uses **hexagonal ventilation holes** in the chassis. Hexagonal holes can be grouped more densely than round holes, providing greater airflow through the system cover.

This cooling scheme is important because newer, more powerful processors generate a significant amount of heat, and heat must be controlled for the system to function properly.

There are temperature sensors on the planar placed to sense DIMM exhaust temperature, SAS HDD exhaust temperature, and CPU2 exhaust temperature (through the altitude sensor).

Light Path Diagnostics

Light path diagnostics enables a technician to quickly identify and locate a failed or failing system component, such as a specific fan or memory DIMM. This enables quick replacement of the component, which helps increase server uptime and lower operating costs.

The front of the server has an LED indicator light to show possible component failures. If the front LED indicates an error condition, by pressing a button on the front of the server an LED panel will pop out and drop down for easy viewing without the need to open the server cover or remove the server from the rack. The light path diagnostics panel tells the servicer which component requires attention. In addition, many components have their own identifying LEDs. For example, each of the memory modules has an LED next to the socket, as do both processors, all adapter slots, all fan modules, all power supplies, the voltage regulator module and the service processor, allowing the servicer to easily identify exactly which component needs servicing. By following the "light path," the component can be replaced quickly, and without guesswork. (*Note:* In the event of a failed DIMM, the system will restart and mark the DIMM as bad while offline, thus allowing the system to continue running, with reduced memory capacity, until serviced.)

Hot-Swap/Redundant Components

System availability is maximized through the extensive use of hot-swap and redundant components, including:

- Redundant memory protection (with Chipkill protection, and memory mirroring enabled)
- Hot-swap, redundant hard disk drives and solid-state drives (with RAID protection)
- Hot-swap, redundant power supplies
- . Hot-swap, redundant cooling fan modules

Other Features

- Five USB 2.0 ports Provides flexibility to add high-speed external devices. The USB 2.0 specification supports up to 480Mbps transfer rates. (*Note:* Not all USB 2.0 devices are capable of achieving this rate.) Two ports are provided on the front of the server, two on the back, plus one USB connector reserved for a USB flash memory key containing an embedded hypervisor. For pre-boot and normal drive use, use the external ports.
- **Dual video ports** To simplify local systems management, **one** video port is provided on the front of the unit and **one** on the back.
- Toolless slides Allows quick rack installation and quicker upgrade and servicing of the server.
- Toolless chassis The cover can be opened without tools, and many components can be removed and replaced without tools, including the optical drive, hot-swap HDDs, plus PCI, PCI-X and PCIe adapters, as well as the integrated ServeRAID card, embedded hypervisor key, and Virtual Media Key. This can save a servicer significant time.

Extensive System Support Features

The IBM services and technical support portfolio provides world-class, consistent, high-quality service and support. The x3550 M3 server offers a number of tools and services designed to make ownership a positive experience. From the start, IBM programs make it easier for you to plan for, configure and purchase System x servers, get them running and keep them running long-term. These features include IBM Express Portfolio, IBM ServerProven[®], IBM Standalone Solutions Configuration Tool, IBM System x and BladeCenter Power Configurator, IBM ServerGuide, IBM Systems Director Service and Support Manager, Product Customization Services and extensive technical support offerings.

The IBM **ServerProven** program provides the confidence that specific options and operating systems have been tested on the server and are officially supported to work together. It is updated frequently to ensure that the latest compatibility information is always at your fingertips.

The IBM **Standalone Solutions Configuration Tool** (SSCT) is a downloadable tool that simplifies the often complex chore of configuring a full rack of servers (including blade servers) and confirming that you have all the cables, power distribution units, KVM (keyboard, video and mouse) switch boxes and other components you need, as well as the proper airflow clearances, electrical circuits and other environmental conditions.

IBM **System x and BladeCenter Power Configurator** helps IT managers plan for data center power needs, by providing the following information for specific configurations of System x and BladeCenter systems: *power input* (watts), *PDU sizing* (amps), *heat output* (BTUs), *airflow requirements through chassis* (CFM), *VA rating*, *leakage current* (mA), and *peak inrush current* (amps)

IBM **ServerGuide** (installed from CD) simplifies the process of installing and configuring System x servers. ServerGuide goes beyond mere hardware configuration by assisting with the automated installation of the Microsoft[®] Windows[®] Server 2003 and 2008 operating systems, device drivers and other system components, with minimal user intervention. (Drivers are also included for support of Novell NetWare, Red Hat Linux and SUSE LINUX.) This focus on deployment helps you reduce both you total cost of ownership and the complexity that administrators and technical personnel face.

IBM Systems Director Service and Support Manager (previously called IBM Electronic Service Agent) is an innovative "call home" feature that allows System x and BladeCenter servers to automatically report hardware problems to IBM support, which can even dispatch onsite service if necessary to those customers entitled to onsite support under the terms of their warranty or an IBM Maintenance Agreement. Service and Support Manager resides on a server and provides electronic support and problem management capabilities through a highly secure electronic dialogue between your systems and IBM. It monitors networked servers for hardware errors and it can perform hardware and software inventories and report inventory changes to IBM. All information sent to IBM is stored in a highly secure database and used for improved problem determination.



Additional services include hardware warranty upgrades and factory-installed **Product Customization Services** (PCS), such as asset tagging, hardware integration, software imaging and operating systems personalization.

IBM offers extensive **technical support** by phone and via the Web. Support options include links to forums/newsgroups, problem submission, online shopping support, service offerings, device drivers for all IBM product lines, software downloads and even upcoming technical seminar worldwide schedules and registration. Also available are remote installation, configuration and usage support for System x hardware and software, as well as onsite custom services to provide the level of expertise you require.

IBM Maintenance and Technical Support solutions can help you get the most out of your IT investment by reducing support costs, increasing availability and simplifying management with integrated support for your multiproduct, multivendor hardware and software environment. For more information on hardware maintenance, software support, solution support and managed support, visit http://ibm.com/services/maintenance.

Advanced Systems Management Capabilities

The x3550 M3 has a high level of systems management capabilities that are well-suited to remote locations as well as to stand-alone environments. Features include UEFI, IMM, IBM ToolsCenter, IBM Systems Director Active Energy Manager, Automatic Server Restart, Wake on LAN® support, PXE support, text console redirect, Predictive Failure Analysis, and IBM Systems Director.

The IMM provides industry-standard Intelligent Platform Management Interface (IPMI) 2.0-compliant systems management. It provides a number of important system functions, including:

- Monitoring of system and battery voltage, system temperature, fans, power supplies, processor and DIMM status
- Fan speed control
- Product ID and Family ID detection
- · Highly secure remote power on/off
- System reset control
- NMI/SMI detection and generation
- · System diagnostic LED control (power, HDD, activity, alerts, heartbeat)
- IPMI over LAN
- Serial Over LAN
- Proxy server support
- LAN messaging and alerting
- Text console redirection over LAN
- · Predictive Failure Analysis for system fans
- · Web-based out-of-band control
- SSL (Secure Socket Layer) and LDAP (Lightweight Directory Access Protocol) support
- Enhanced authentication and encryption algorithms (RMCP+ and AES)
- VLAN support
- Local update of IMM firmware
- Firmware firewall
- Support for IPMI v2.0 compliant management software (e.g., xCAT)
- Other mandatory and optional IPMI IMM functions

The IMM alerts IBM Systems Director to anomalous environmental factors, such as voltage and thermal conditions—even if the server has failed.

The x3550 M3 also supports an optional IBM Virtual Media Key for additional systems management capabilities, including:

- · Latest OS failure screen capture
- Graphical console redirection over LAN
- Remote virtual floppy and CD-ROM
- · High-speed remote redirection of PCI video, keyboard and mouse

IBM **ToolsCenter** consolidates 42 needed tools for managing servers individually into an integrated suite of 8 tools. They are organized by function: deployment, updates, configuration and diagnostics. Tools are now simpler to access and use with a single webpage for access, a common look and feel and a common command line interface for the scripting tools. The ToolsCenter **Bootable Media Creator** offers significantly more functionality than past tools with

the ability to add more tools to the bootable image and to automatically download the bootable environment if needed. Bootable Media Creator allows you to create bootable CDs, DVD, and USB keys for updates customized to your systems.

IBM developed IBM **Systems Director Active Energy Manager** to put control of system power-saving features at the fingertips of administrators. Active Energy Manager is designed to take advantage of new features, such as monitoring power usage and balancing the performance of the system according to available power input. It provides the ability to plan and predict power consumption based on your hardware configuration. It also helps enable you to reduce the infrastructure required for redundancy, by using fewer servers on smaller power feeds and potentially lowering your overall data center support costs. It does this by inventorying all components, then adding up the total power draw and tracking the usage. It also includes power management features to help administrators manage or reduce power usage.

Automatic Server Restart (ASR) helps reduce downtime by restarting the server automatically in the event of a system lockup. ASR technology is a combination of hardware circuitry tied into the server's system reset function and a device driver. As long as the server continues running, the ASR watchdog timer will keep being reset, but if the operating system crashes or the hardware freezes somehow the ASR software will be unable to reset the hardware timer. If the timer is not reset within five minutes, it automatically triggers the ASR hardware, which immediately restarts the server (and logs an ASR event with IBM Systems Director). These features are designed so that *no more than five minutes can pass before the server is restarted*.

Wake on LAN permits the server to be remotely powered on if it has been shut off. Once powered up, the server can be controlled across the network, using the **Preboot Execution Environment** (PXE).

Like Wake on LAN, **PXE** is system firmware. It enables software such as the optional **IBM Remote Deployment Manager** to take control of a system before the BIOS, operating system or applications are loaded (using Wake on LAN/PXE) and lets an administrator perform many low-level tasks remotely that would otherwise require a visit to each system. These tasks may include such things as formatting a hard disk drive, updating system firmware, or deploying a Windows or Linux operating system.

Text Console Redirection support allows the administrator to remotely view x3550 text messages over serial or LAN. An optional upgrade to the Virtual Media Key adds graphical console redirection.

Predictive Failure Analysis (PFA) is designed to allow the system to detect impending failure of supported components (processors, memory, HDDs, voltage regulator modules (VRMs), power supplies and fans) *before* actual failure, and alert the administrator through IBM Systems Director. This gives you the ability to *replace* the failing component *before* it fails, resulting in increased uptime.

IBM Systems Director software for advanced workgroup management is included with the x3550 M3. IBM Systems Director comes with a portfolio of tools, including **IBM Systems Director Active Energy Manager**, **Service and Support Manager**, and others. Others are available as add-ons for additional server management and increased availability. IBM Systems Director provides a single uniform graphical interface for all of these systems management functions.

IBM Systems Director enables you to customize thresholds and monitor system components (for things like temperature, voltage regulation, etc.) to help maximize uptime.

Key Options

IBM options for System x servers help you take your servers to a higher level

You know can rely on System x options to supply a complete solution for your business needs. Options help you create an optimized server system to meet your data protection, storage and availability needs. Every IBM option is designed and tested for peak performance and flexibility, helping to maximize your return on investment. The combination of System x servers and options lets you keep your fingers on the pulse of your e-business.

Processors —Intel Xeon processors provide high clock rates, 4 or 6 cores, and advanced features for performance, availability and power management. Large cache size, combined with fast **1333MHz**, **1066MHz** or **800MHz** memory access and an integrated memory controller reduce memory latency and facilitate the movement of data. (*Note:* System performance depends not only on the number of processors in the server but also on the frequency and functionality of each processor.) Adding a second processor may be a cost-effective way to achieve significant performance improvements.

Memory — Memory is a major factor in systems application performance. Adding more memory to a System x server is one of the most effective ways to increase application performance. For best performance in a server with a **4-core** processor, there should be twice as much memory as for a 2-core processor. A **6-core** processor should have three times as much memory as a 2-core processor.

Hard Disk Drives — IBM hard disk drives help you improve the transaction and cost performance of your System x servers. The choice of hard disk drives can be a critical aspect of maximizing the I/O throughput of the system. 2.5-inch SAS hard disk drives are available for the x3550 M3 with capacities of up to 1TB at 7,200 RPMs, up to 600GB at 10K RPMs, and up to 146.8GB at 15,000 RPMs. 2.5-inch SATA HDDs are available in capacities up to 1TGB at 7,200 RPMs and 300GB at 10K RPMs

Solid State Drives — IBM solid-state drives offer high **IOPS** (I/O operations per second) performance and the ultimate in reliability, with 3X the MTBF (mean time between failure) rate of enterprise HDDs. IBM SSDs. are available in **50GB** capacities. They can be used as a highly available boot drive, for storing disk images, or for other uses that stress read performance.

Power Supply — The optional second power supply for the x3550 M3 enables redundancy for hot-swap power. Its design, up to **95%-efficient**, helps lower your energy bill for power and cooling.

Virtual Media Key — The x3550 M3 includes a plethora of systems management features built-in; however, sometimes additional management capability is needed. In those situations, the Virtual Media Key not only offers powerful new features, it does so without taking up a valuable PCI-X or PCIe adapter slot, instead using a dedicated slot on the motherboard.

ServeRAID Controllers — System x servers using ServeRAID technology allow companies to build a reliable foundation for business-critical computing. IBM ServeRAID technology allows an array consisting of multiple physical hard disk drives to be treated as one logical drive. ServeRAID technology also allows data to be stored redundantly, across multiple hard disk drives—enhancing both the integrity and the availability of the data. SAS and SATA ServeRAID controllers offer enhanced performance due to onboard processors and cache. Because IBM ServeRAID controllers can help significantly improve data transfer rates, this technology is extremely effective when implementing demanding, transaction-oriented applications. By employing the advanced fault tolerance of IBM ServeRAID technology, companies can effectively implement networked business systems that require large amounts of storage space for data and applications that must be available for their businesses to continue operating.

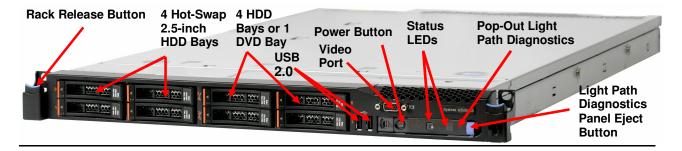
The ServeRAID-BR10il v2 SAS/SATA Controller offers RAID-0/1/1E support, with up to 3Gbps per SAS port. The IBM ServeRAID-M1015, x8 PCIe and 6Gbps, offers RAID-0/1/10; optionally RAID-5/50 with SED support. The IBM ServeRAID-M5014, x8 PCIe and 6Gbps, provides 256MB cache and RAID-0/1/10/5/50; optionally RAID-6/60 with SED, and battery backup). The IBM ServeRAID-M5015, x8 PCIe and 6Gbps, includes 512MB of battery-backed cache standard and RAID-0/1/10/5/50; optionally RAID-6/60 with SED. For external storage, the ServeRAID-M5025 controller provides RAID-0/1/10/5/50 support and 512MB of onboard cache and enables connection to up to four IBM System Storage SAS/SATA expansion units (240 HDDs total). The IBM ServeRAID M1000 Series Advance Feature Key adds RAID-5/50 and SED support to the ServeRAID-M1015. Similarly, the IBM ServeRAID M5000 Series Advance Feature Key adds RAID-6/60 with SED support to the M5014, M5015, and M5025. The IBM ServeRAID M5000 Series Battery Key adds battery backup support to the M5014 and CTO servers containing an M5015 or M5025.

External Storage — The IBM System Storage EXP810 expansion unit, as well as the DS3000, DS4000, and DS8000 Series storage subsystems and N3000, N5000, N6000, and N7000 NAS systems comprise a powerful and broad shared storage family with integrated management software designed to meet midrange and enterprise needs.

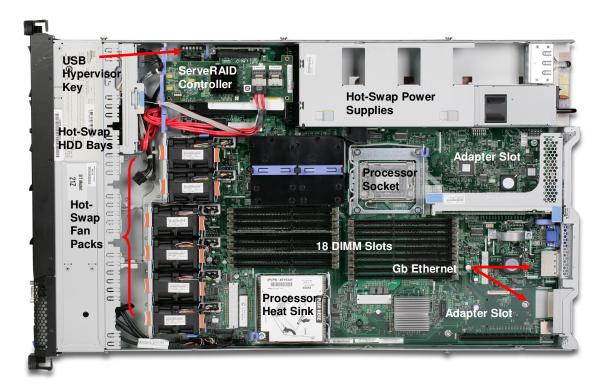
External SAN, iSCSI, and direct-attach storage is available using one of several IBM System Storage host bus adapters. External LAN-attached tape storage is available.

IBM System x3550 M3 Images

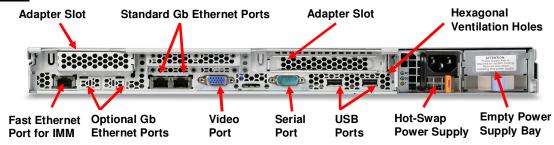
Front View



Inside View



Rear View



IBM System x3550 M3 Specifications								
Machine type	7944-12x, 22x, 32x, 52x/54x, 0	7944-12x, 22x, 32x, 52x/54x, 62x, 72x, 82x, D4x, H4x, J4x						
Form factor	11	1U						
Processor type	6-Core Xeon (E56xx/L56xx/X56xx) 2.26GHz L5640 (H4x), 2.4GHz E5645 (52x/54x), 2.53GHz E5649 (62x), 2.66GHz X5650 (J4x), 2.8GHz X5660 (via CTO), 3.06GHz X5675 (72x), 3.46GHz X5690 (82x)	4-Core Xeon (E56xx/L56xx/X56xx) 1.6GHz E5603 (12x), 1.86GHz L5609 (CTO), 2.13GHz E5606 (22x), 2.13GHz L5630 (CTO), 2.26GHz E5607 (32x), 2.4GHz E5620 (D4x), 2.93GHz X5647 (CTO), 3.2GHz X5672 (CTO), 3.6GHz X5687 (CTO),						

IBM System x3550 M3 Specifications									
Maximum processor power draw	130W —82x (X5647/X5687 via CTO)	95W — 72x, J4 (X5660/X! via CT0	x 5672	22x, 3 52x/54x	1 W —12x, 2x, 32x, ½54x, 62x, D4x		W —H4x	40W — L5609/L5630 via CTO	
QuickPath Interconnect (QPI) speed (gigatransfers per second)	6.4GTps 5.86G 6.4GTps (72x, 82x, J4x, X5660/X5672/X5687 via CTO) D4x, H4x, L X5647 vi			2x/54x, 62x, L5630 and 4.8GTps (12x, 22x, 32x, L5609 via CTO)					
# of processors standard / maximum		2 / 2 (54x) 1 / 2 (all other mod					er models)		
Hyper Threading Technology supported	72x, 82x, D	4x, H4x, J4x	e)—52x/54x, 62x, k, J4x, L5630, /X5687 via CTO No—12x, 22x, 32x, L5609 vi				L5609 via CTO		
Turbo Boost Technology supported	Yes—52x/54x, J4x, L5630, X56							L5609 via CTO	
Internal L3 cache	12MB (1 share cache)—(all oth			8MB (1 shared 8MB cache)—(22x,32x)			4MB (1 shared 4MB cache)—(12x)		
Chipset				Intel 5	520				
Standard memory (192GB maximum)	8GB (2 x 4GB)—54x				4GB (1 x 4GB)—12x, 22x, 32x, 52x, 62x, 72x, 82x, D4x, H4x, J4x				
# of DIMM sockets total / available	18 / 16 —54x				18 / 17 —12x, 22x, 32x, 52x, 62x, 72x, 82x, D4x, H4x, J4x				
Standard memory voltage	1.35V								
Standard memory type	Registered PC3-10600 (DDR III ECC (Chipkill protection standard)—Single-rank)—Single-rank x4			
Maximum memory access speed	1333MHz (52x/54x, 62x, 72x, 82x, H4x, J4x, X5660/X5672/X5687 via CTO) 1066MHz (12x, 22x, L5609/L5630, X5647)								
Memory interleaving		Ye	'es (two-way using pairs DIMMs)						
DIMM types / capacities supported	PC3-106 1333MHz R 2GB 1R x8, 2GB 2R x8 4GB 1R x4 4GB 2R x4 4GB 2R x8 8GB 2R x4	1.35V; 1.35V; 1.35V; 1.35V; 1.35V;		PC3-10600 1333MHz UDIMM 2GB 1R x8 1.35V; 4GB 2R x8 1.35V			PC3L-8500R 1066MHz RDIMM 8GB 2R x4 1.35V; 16GB 4R x4 1.35V		
Supports 1333MHz with 2 DIMMs per channel	L5640 and 1333MHz E56xx and X56xx processors support 2DPC at 1333MHz								
Online hot-spare memory supported	Yes on 5600 series								
Memory mirroring supported / # of DIMM sockets reserved for mirroring	Yes / 1 channel (3 slots per processor) active, 1 spare, 1 unused								
# of HDD drive bays total / available	8 / 8 (2.5-inch)				4 / 4 (2.5-inch) with internal optical drive				
# of 5.25" bays total / available	1/1								
Maximum drive capacity	2.5-inch SAS/SATA 8TB ⁹ (8 x 1TB) hot-swap	4TB		ATA TB) hot- Optical	2.5-inch SSD 400GB (8 x 50GB) 50GB hot-swap or sim		2.5-inch SSD 200GB (4 x 50GB) hot-swap or simple-swap, with Optical drive		

⁹ 1TB drives available in 2Q/2011.

IBI	M System x3550 l	ИЗ Sp	ecificatio	ns			
Drive capacities supported	2.5-inch HS SA 500GB, 1TB—7.2 146.8, 300, 600GB— 73.4, 146.8GB—1	K; - 10K;	2.5-inch HS SATA 160, 250, 500GB, 1TB— 7.2K		2.5	2.5-inch HS or SS SSD 50GB	
# of HDDs standard	None (all models open bay)						
# of optical drives standard	None (optional DVD-RW)						
# of diskette drives standard	None (optional)						
Storage technology	Hot-swap SAS/SATA; also hot-swap or simple-swap SSD						
Integrated disk controller	LSI 1068						
# of disk drives supported per port			1				
Integrated RAID controller standard	ServeRAID-M5015 (512MB cache, includes battery, except CTO servers)—RAID- 0/1/10/5/50; optional RAID-6/60 with SED; 6Gbps; supports 8 drives (72x, 82x, J4x)	M50 cac option 0/1 option 6/60 option 6Gbp	ServeRAID- M5014 (256MB cache, battery ptional)—RAID- 0/1/10/5/50; pptional RAID- 5/60 with SED, ptional battery; Gbps; supports drives (52x/54x, 62x) ServeRA M1015 (cache)—R 0/1/10; opt RAID-5/50 SED, 6Gk supports 8 ((22x, 32x,		no AID- onal with ps; Irives	ServeRAID- BR10iI v2 (no cache)— RAID-0/1/1E, 3Gbps; supports 4 drives (12x)	
Optional internal RAID controllers supported	ServeRAID- M1015 —	-12X	ServeRAID- M5014 (battery optional)—12 22x, 32x, D4x		ServeRAID- M5015 (includes battery)—12x, 22x, 32x, 52x/54x, 62x, D4x		
External disk drives supported	Yes, via the optional 6Gbps ServeRAID-M5025 controller (512MB cache, RAI 0/1/10/5/50, and battery backup standard—SAS/SATA; optional RAID-6/60 with						
# of adapter slots total / available	2 / 2 (2 / 1 when using the CTO Emulex 10GbE Integrated Virtual Fabric Adapter)						
# of PCle x16 Gen 2 slots (16GBps)	2 via 2 risers (1 full-height/half-length, 1 low-profile/full-length						
# of PCIe x8 Gen 2 slots (8GBps)	None						
# of PCI-X/133 slots (1GBps)	None standard (1 or 2 via optional risers in place of the PCIe risers)						
# of 33MHz legacy PCI slots	None						
# of video ports	2 (one front, one rear)						
Video controller	Matrox G200eV (in IMM) standard (NVIDIA FX580 available for CTO and special-bid models)						
Video memory	16MB DDR2 SDRAM						
Maximum video resolutions	1280x1024 at 60Hz (32 bits) 1600x1200 at 85Hz (16 b					at 85Hz (16 bits)	
Gigabit Ethernet controller	Broadcom BCM5709S						
TOE/iSCSI/RDMA acceleration	TOE only						
# of Gigabit Ethernet ports	2 standard plus 2 optional						
# of RS485 ports	None						
# of serial ports	1 (rear)						
# of parallel ports	None (USB-attached)						
# of mouse ports	None (USB-attached)						
# of keyboard ports			None (USE	3-attached)			
# of USB 2.0 ports	5 (2 front, 2 rear, 1	interna	for a USB flas	sh memory key	/ contai	ining an embedded	

IBM System x3550 M3 Specifications							
	hypervisor)						
Integrated systems management controller	Yes (IMM)						
Optional systems management adapter	Virtual Media Key (optional)						
Light path diagnostics support	Yes, with external pop-out/drop-down panel						
Predictive Failure Analysis (PFA) support	Processors, memory, voltage regulator modules (VRMs), power supplies and fans						
Power supply type	AC or DC, universal, autoswitching, hot-swap						
Power supply standard	460W (12x, 22x, 32x, 52x, 62x, D4x, H4x)—80 Plus Gold; up to 92% efficient	675W (72x, J4x)		675W high-efficiency (54x, 82x)—Up to 95% efficient			
Optional power supply (replaces standard)	Second PS of the sam	ie type	1 or 2 675\	W -48V DC power supplies as replacement(s)			
# of power supplies standard / maximum	2 / 2 (54x)		1	/ 2 (all other models)			
Hot-swap/redundant power supported	Yes (alled)					
# of fans modules standard / maximum	6 / 6 (54x)		5 / 6 (all other models)				
Hot-swap/redundant fans supported	Yes (standard)						
NEBS 1/ETSI compliance	Equivalent compliance for both AC and DC power supply (model depe						
Energy-efficiency standards compliance	Compliant with 80 PLUS Gold and ENERGY STAR standards (model depende						
Rack mount method	Slides and Cable Management Arm (provided standard)						
Maximum altitude							
Operating temperature range	50 – 95° F; 10 – 35° C (up to 3,000 ft / 914.4 m)		50 – 90° F; 10 – 32° C (3,000 ft to 7,000 ft / 914.4m to 2,133m)				
Dimensions (HWD) / weight	1.69" (43mm) H 17.3" (440mm) W 28.0" (711.4mm) D			28 (minimum) – 35.1 lb (maximum) 12.7 – 15.9 kg			
Operating systems supported	Microsoft Windows Server 2008 / 2008 R2, 32/64-bit; Microsoft Windows Server 2003 2003 R2 (Standard/Enterprise/Web/Datacenter/Datacenter with UV), 32/64-bit; RHEL 32/64-bit, with and without Xen; RHEL 6 32/64-bit; SLES 10/11 32/64-bit with and without Xen; VMware vSphere Hypervisor 4.1; Sun Solaris 10 (model dependent)						
Length of limited warranty	3 years (parts and labor) ¹⁰						

The Bottom Line

The IBM System x3550 M3 is an extremely energy efficient, powerful system, incorporating significantly redesigned management tools and abundant IBM-unique innovations:

Price/Performance

- High-throughput processors Up to two 2.40 to 3.46GHz 6-core, 1.6GHz to 3. 6GHz 4-core; 2.26GHz low-voltage 6-core or 1.86GHz to 2.13GHz low-voltage 4-core Xeon 5600 series processors
- Energy-efficient low-voltage processors 40W 4-core and 60W 6-core Xeon 5600 series processors

¹⁰ For terms and conditions or copies of the IBM Statement of Limited Warranty, call 800-772-2227 in the U.S. In Canada call 800-426-2255. IBM makes no representation or warranty regarding third-party products or services including those designated as ServerProven or ClusterProven. Telephone support may be subject to additional charges. For warranties including onsite labor, a technician is sent after IBM attempts to resolve the problem remotely. International warranty service is available in any country in which this product is sold.

- Hyper Threading Technology for up to 12 processor cores and 24 threads total (processor-specific)
- Turbo Boost Technology for a performance boost when not all cores are in use (processor-specific)
- Large cache 4MB-12MB of L3 processor cache (processor-specific)
- Fast memory Registered PC3-10600 DDR III ECC DIMMs standard, operating at 1333MHz or 1066MHz (depending on processor model and memory configuration); supports 2 DIMMs per channel at 1333MHz (processor-specific)
- Fast disk technology Supports high-performance SAS drives that provide high density/high reliability and allow you to scale up as your business grows.
- High IOPS SSDs Solid-state drives offer significantly higher I/O operations per second than HDDs
- Fast communications Integrated dual Gigabit Ethernet controllers standard supporting load-balancing and failover; two additional NICs optional
- Fast I/O Two PCIe x16 adapter slots (replaceable with two PCI-X/133 slots)

Flexibility

- Large memory capacity Up to 192GB of registered DDR3 DIMMs, in 18 DIMM slots
- Up to 8 2.5-inch hot-swap SAS/SATA HDDs or SSDs or simple-swap SSDs
- Choice of disk storage Up to 8TB of internal SAS/SATA storage, 400GB of internal solid-state storage
- High-performance external expansion Five 480Mbps USB 2.0 ports (two front, two rear, one internal for an optional USB key with hypervisor)
- Slotless hardware-based 3Gbps RAID-0/1/1E, or 6Gbps RAID-0/1/10 or RAID-0/1/10/5/50 standard
- Two available adapter slots
 - Two x16¹¹ PCle slots (Gen2)
 - An optional riser card containing one 133MHz PCI-X slot can replace the riser card containing each of the PCIe slots
- Optional DVD-RW drive
- Choice of 3 power supplies standard (460W, 675W, 675W high-efficiency, plus an optional 675W DC (replaces standard AC power supplies)
- Two video ports (one on the front and one on the back)

Manageability, Serviceability and Availability

- IBM Systems Director systems management software, including (among others:
 - □ IBM Systems Director Active Energy Manager
 - ☐ IBM Service and Support Manager
- Integrated Management Module (IMM):
 - ☐ IPMI 2.0 compliance, including highly secure remote power control
 - ☐ Text console redirection systems management standard
- Active Memory protection:
- ☐ Advanced Chipkill ECC memory protection support
 - Memory mirroring
- Integrated slotless ServeRAID controller enhances system availability and serviceability without using a PCIe slot
- A combination of hot-swap SAS/SATA HDDs or SSDs, or simple-swap SSDs—for quicker servicing than with fixed drives
- Solid-state drives as a high-reliability alternative to internal storage (with up to three times the MTBF of spinning disk drives)
- Ultra-efficient cooling incorporating Calibrated Vectored Cooling features and hot-swap/redundant fan modules
- Standard or optional hot-swap/redundant power supplies (model-specific)
- Light path diagnostics (front LED panel, pop-out/drop-down light path panel)
- Optional Virtual Media Key daughter card (no slot required)

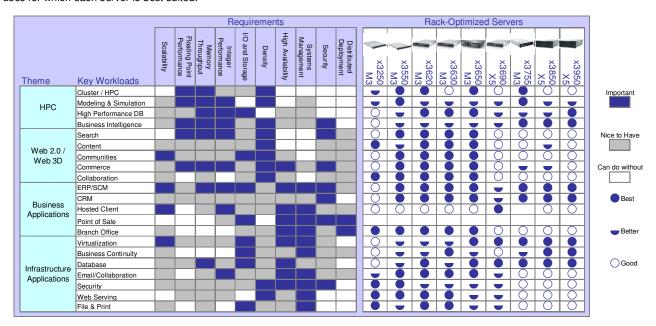
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¹¹ The x8 slots can accept x1, x4, or x8 adapters running at x1, x4, or x8 throughput, respectively.

- ☐ Supports **LDAP** and **SSL** industry standards
- Toolless chassis and toolless slide design; integrated Cable Management Arm

Server Comparison Chart

The following table shows the suggested uses for the respective IBM System x rack-optimized servers, including comparisons of the uses for which each server is best suited:





For More Information

IBM System x Servers

IBM Systems Director Service and Support Manager

IBM System x and BladeCenter Power Configurator

IBM Standalone Solutions Configuration Tool

IBM Configuration and Options Guide

IBM ServerProven Program

Technical Support

Other Technical Support Resources

http://ibm.com/systems/x

http://ibm.com/support/electronic

http://ibm.com/systems/bladecenter/resources/powerconfig.html

http://ibm.com/systems/x/hardware/configtools.html

http://ibm.com/systems/x/hardware/configtools.html

http://ibm.com/systems/info/x86servers/serverproven/compat/us

http://ibm.com/server/support http://ibm.com/systems/support

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MB, GB and TB = 1,000,000, 1,000,000,000 and 1,000,000,000,000 bytes, respectively, when referring to storage capacity. Accessible capacity is less; up to 3GB is used in service partition. Actual storage capacity will vary based upon many factors and may be less than stated.

Performance is in Internal Throughput Rate (ITR) ratio based on measurements and projections using standard IBM benchmarks in a controlled environment. The actual throughput that any user will experience will depend on considerations such as the amount of multiprogramming in the user's job stream, the I/O configuration, the storage configuration and the workload processed. Therefore, no assurance can be given that an individual user will achieve throughput improvements equivalent to the performance ratios stated here.

Maximum internal hard disk and memory capacities may require the replacement of any standard hard drives and/or memory and the population of all hard disk bays and memory slots with the largest currently supported drives available. When referring to variable speed CD-ROMs, CD-Rs, CD-RWs and DVDs, actual playback speed will vary and is often less than the maximum possible.

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